

Multilayer Ceramic Chip Capacitors

CGA5L1X7R1V106K160AC



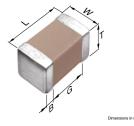






TDK item description CGA5L1X7R1V106KT****

Applications	Automotive Grade	
Feature	General General (Up to 50V) AEC-Q200 AEC-Q200	
Series	CGA5(3216) [EIA 1206]	
Status	Production	



	Size
Length(L)	3.20mm ±0.20mm
Width(W)	1.60mm ±0.20mm
Thickness(T)	1.60mm ±0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	1.00mm Min.
Recommended Land Pattern (PA)	2.10mm to 2.50mm(Flow Soldering)
Recommended Land Fattern (FA)	2.00mm to 2.40mm(Reflow Soldering)
Recommended Land Pattern (PB)	1.10mm to 1.30mm(Flow Soldering)
Recommended Land Fattern (FB)	1.00mm to 1.20mm(Reflow Soldering)
Recommended Land Pattern (PC)	1.00mm to 1.30mm(Flow Soldering)
Neconinienaea Lana Fattern (PC)	1.10mm to 1.60mm(Reflow Soldering)

Electrical Characteristics		
Capacitance	10μF ±10%	
Rated Voltage	35VDC	
Temperature Characteristic	X7R(±15%)	
Dissipation Factor (Max.)	5%	
Insulation Resistance (Min.)	50ΜΩ	

Other	
Caldaring Mathad	Wave (Flow)
Soldering Method	Reflow
AEC-Q200	Yes
Packing	Blister (Plastic)Taping [180mm Reel]
Package Quantity	2000pcs

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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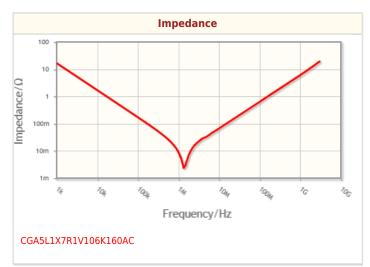


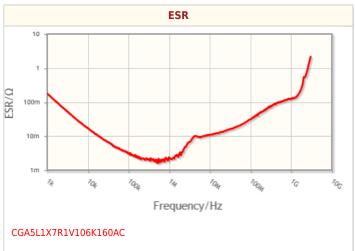


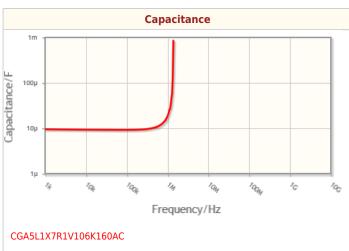




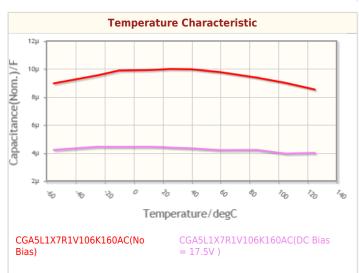
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

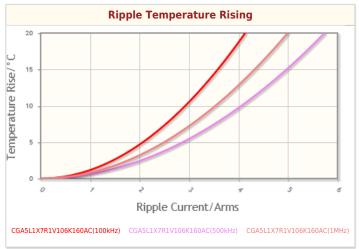












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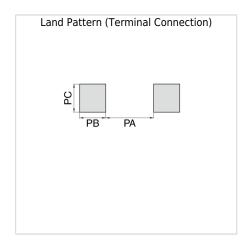








Associated Images



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